583854-3 - ACTIVE

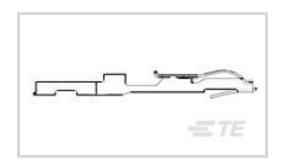
AMPMODU

TE Internal #: 583854-3 Connector Contact, Socket, Wire-to-Board, Gold, Loose Piece, Wire & Cable, Power & Signal

View on TE.com >



Connectors > PCB Connectors > Wire-to-Board Connectors > Wire-to-Board Connector Contacts



Contact Type: Socket Connector System: Wire-to-Board Centerline (Pitch): 2.54 mm [.1 in] Contact Mating Area Plating Material: Gold Packaging Method: Loose Piece

Features

Product Type Features

	Connector System	Wire-to-Board	
	Connector & Contact Terminates To	Wire & Cable	
Contact Features			

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(ontact	Retention	WUThin	Housing	
Contact	NULUIIUII		Indusing	

With

	30 µin			
Wire Contact Termination Area Plating Material	Tin			
Contact Underplating Material	Nickel			
PCB Contact Termination Area Plating Material	Tin			
Contact Base Material	Phosphor Bronze			
Contact Type	Socket			
Contact Mating Area Plating Material	Gold			
Termination Features				
Termination Method to Wire & Cable	Solder Eyelet			
Mechanical Attachment				
Contact Retention Type Within Housing	Locking Lance			
Housing Features				
Centerline (Pitch)	2.54 mm[.1 in]			
Operation/Application				

C For support call+1 800 522 6752

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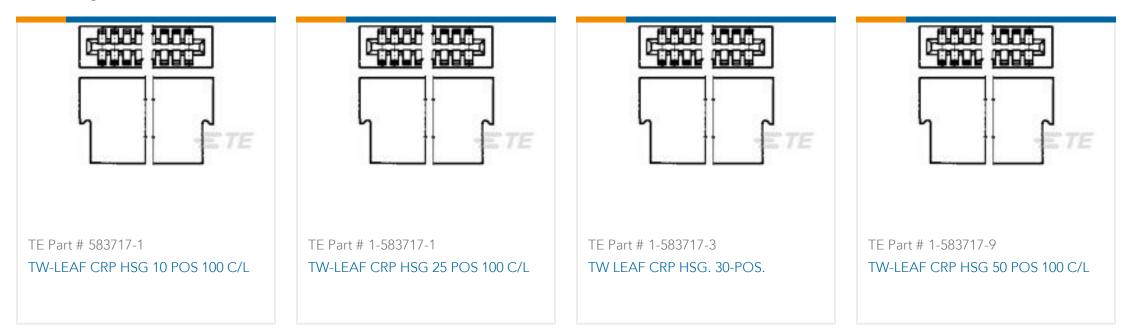


Circuit Application	Power & Signal
Packaging Features	
Packaging Quantity	5000
Packaging Method	Loose Piece
Product Compliance For compliance documentation, visit the product page on TE.com>	
EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Not applicable for solder process capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts

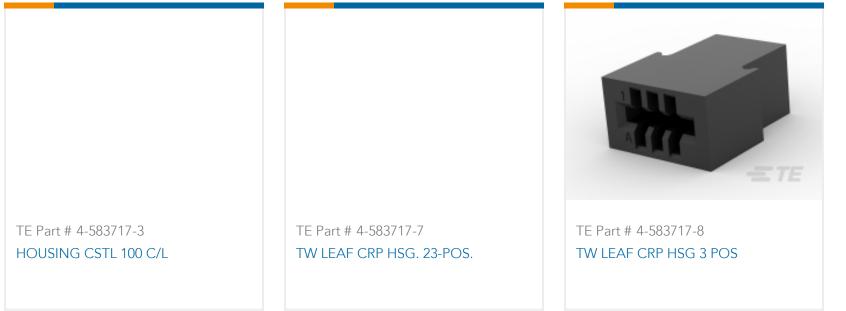


583854-3

Connector Contact, Socket, Wire-to-Board, Gold, Loose Piece, Wire & Cable, Power & Signal







Customers Also Bought



583854-3

Connector Contact, Socket, Wire-to-Board, Gold, Loose Piece, Wire & Cable, Power & Signal







Documents

Product Drawings TWIN LF SOLD EYE CONTACT

English

CAD Files 3D PDF

3D

Customer View Model ENG_CVM_CVM_583854-3_AV.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_583854-3_AV.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_583854-3_AV.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Specifications
Product Specification
English
Product Specification

English